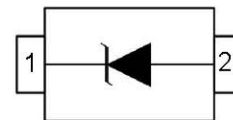


● Micro-Packaged Diodes for ESD Protection

The ESD5Z Series is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its small size, it is suited for use in cellular phones, portable devices, digital cameras, power supplies and many other portable applications.



● Specification Features:

- ① Small Body Outline Dimensions:
0.047, x 0.032, (1.20 mm x 0.80 mm)
- ① Low Body Height: 0.028, (0.7 mm)
- ① Stand-off Voltage: 2.5 V – 7.0 V
- ① Peak Power up to 200 Watts @ 8 x 20 μ s Pulse
- ① Low Leakage
- ① Response Time is Typically < 1 ns
- ① ESD Rating of Class 3 (> 16 kV) per Human Body Model
- ① IEC61000-4-2 Level 4 ESD Protection
- ① IEC61000-4-4 Level 4 EFT Protection

● Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic
Epoxy Meets UL 94 V-0
LEAD FINISH: 100% Matte Sn (Tin)

● MOUNTING POSITION: Any

QUALIFIED MAX REFLOW TEMPERATURE: 260 °C
Device Meets MSL 1 Requirements

● MAXIMUM RATINGS

Rating	Symbol	Value	Unit
IEC 61000-4-2 (ESD) Air Contact		+30 +30	kV
IEC 61000-4-4 (EFT)		40	A
ESD Voltage Per Human Body Model Per Machine Model		16 400	kV V
Total Power Dissipation on FR-5 Board (Note 1) @ T _A = 25 °C	P _D	100	mW
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C
Lead Solder Temperature – Maximum (10 Second Duration)	T _L	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-5 = 1.0 x 0.75 x 0.62 in.

ORDERING INFORMATION

Device	Package	Shipping†
ESD5Zxx	SOD-523	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

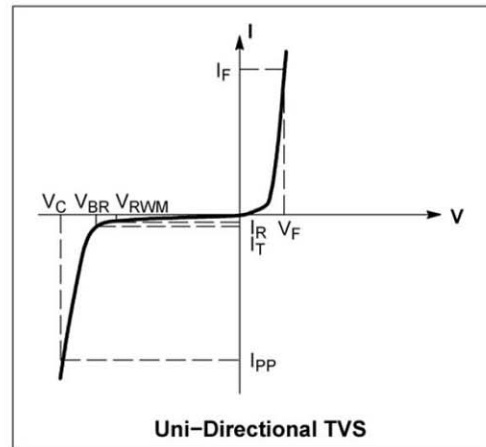
DEVICE MARKING INFORMATION

See specific marking information in the device marking column of the Electrical Characteristics tables starting on page 2 of this data sheet.

● ELECTRICAL CHARACTERISTICS

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_F	Forward Current
V_F	Forward Voltage @ I_F
P_{pk}	Peak Power Dissipation
C	Max. Capacitance @ $V_R = 0$ and $f = 1$ MHz



● ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted, $V_F = 0.9$ V Max. @ $I_F = 10$ mA for all types)

Device**	Device Marking	V_{RWM} (V)	I_R (μA) @ V_{RWM}	V_{BR} (V) @ I_T (Note 2)	I_T	V_C (V) @ $I_{PP} = 5.0$ A*	V_C (V) @ Max I_{PP} *	I_{PP} (A)*	P_{pk} (W)*	C (pF)
		Max	Max	Min	mA	Typ	Max	Max	Max	Typ
ESD5Z2.5	ZD	2.5	6.0	4.0	1.0	6.5	10.9	11.0	120	145
ESD5Z3.3	ZE	3.3	1.0	5.0	1.0	8.4	14.1	11.2	158	105
ESD5Z5.0	ZF	5.0	1.0	6.2	1.0	11.6	18.6	9.4	174	80
ESD5Z6.0	ZG	6.0	1.0	6.8	1.0	12.4	20.5	8.8	181	70
ESD5Z7.0	ZH	7.0	1.0	7.5	1.0	13.5	22.7	8.8	200	65

**Other voltages available upon request.

*Surge current waveform per Figure 1.

2. V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C .

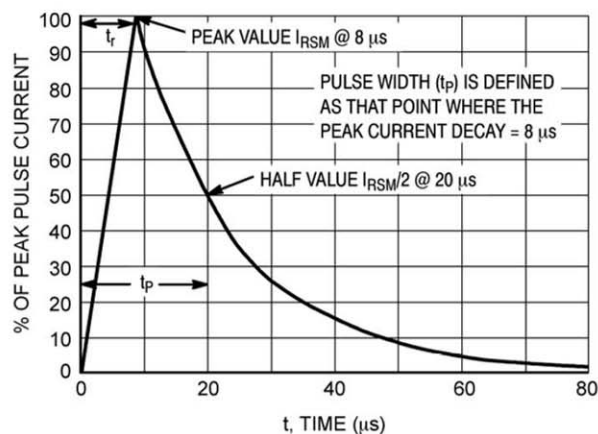
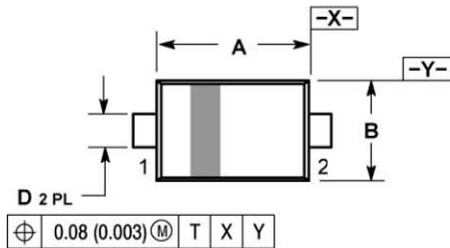


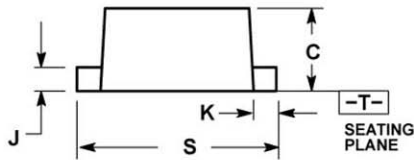
Figure 1. 8 x 20 μs Pulse Waveform



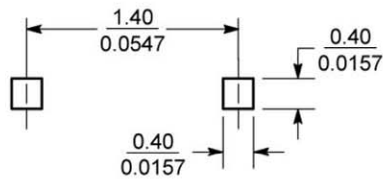
SOD-523
CASE 502-01
ISSUE A

- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.10	1.20	1.30	0.043	0.047	0.051
B	0.70	0.80	0.90	0.028	0.032	0.035
C	0.50	0.60	0.70	0.020	0.024	0.028
D	0.25	0.30	0.35	0.010	0.012	0.014
J	0.07	0.14	0.20	0.0028	0.0055	0.0079
K	0.15	0.20	0.25	0.006	0.008	0.010
S	1.50	1.60	1.70	0.059	0.063	0.067



SOLDERING FOOTPRINT



SCALE 10:1 $\left(\frac{\text{mm}}{\text{inches}}\right)$

单击下面可查看定价，库存，交付和生命周期等信息

[>>SHIKUES\(时科\)](#)